SIGNATURE LINE®

ENHANCE®

SURFACE BOND PROMOTER & ENCAPSULATOR



PRODUCT HIGHLIGHT

RESIDENTIAL

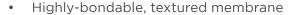
MULTI-FAMILY

COMMERCIAL

Take your job site to the next level with **Enhance**. Its multi-functioning capabilities tackle many tough challenges such as detackifying or encapsulating existing adhesive residue, including cutback. Even difficult-to-bond substrates are no match for the textured surface profile Enhance provides.



WHY USE



- Primes difficult-to-bond substrates
- Protects flooring from alkali attack
- Encapsulates cutback residue
- · Detackifies existing adhesive residue
- Seals porous substrates
- Simple, 1-part installation (roller-applied)
- Rapid 1-2 hour cure time
- Primes Sahara for glue-down applications
- Extremely low VOC, extremely low odor
- Solvent and isocyanate-free











COVERAGE: Up to 250 ft²/gal AVAILABLE IN: 2 gal SHELF LIFE: 1 year



EXTREMELY **LOW**

ODOR











CURE TIME

